10/03/2024 11:12

DNR-MIL-6 6-Slot, Military-Grade I/O Rack





- Military/Rugged 38999 connectivity
- 100% COTS solution
- Supported by over 90 standard DNR-series I/O boards
- 5g vibration, 100g shock, sealed to IP66
- Dual GigE ports (control and diagnostic)
- Designed for MIL-STD-461/810/1275 compliance
- Extensive built-in system diagnostics
- PowerDNA, UEIPAC, UEIMODBUS, UEISIM and UEIOPCUA configurations
- No rotary cooling devices
- Extensive software support including Windows, Linux, VxWorks, QNX, RTX and more
- VxWorks support available in embedded or hosted configurations

General Description

The DNR-MIL-6 is the latest deployment of UEI's popular RACKtangle® architecture. It is basically a smaller version of UEI's popular DNR-MIL, and offers slots for six I/O boards, rather than the DNR-MIL's twelve. Designed for use in the toughest environments, the DNR-MIL-6 is ideal for military and aerospace deployments. It is also ideal for a huge assortment of commercial applications, including oil drilling platforms and refineries, heavy machinery, outdoor test stands and any other I/O application that will be exposed to the elements. All connectivity is through ROHS compliant 38999 connectors.

Electronically, the DNR-MIL-6 is identical to the standard DNR Series RACKtangle, except for hold-up and protection circuitry on the power supply inputs to meet MIL-STD-1275/704. This means the DNR-MIL-6 uses standard DNR-series boards (e.g. DNR-AI-217 or DNR-1553-553). With over 90 unique I/O boards and 6 slots available, there's sure to be a configuration matching your application.

The new DNR-MIL-6 is designed to meet the most commonly required elements of MIL-STD-461 and -810, and is sealed to at least IP66/NEMA6 standards. All this is housed in a compact 11.6" W x 6.4" D x 7.0" H chassis, weighing approximately 16 pounds and typically consuming less than 30 W. Heat transfer from the internal electronics to the external chassis is designed such that no fans or rotary cooling is required. The lack of fans maximizes MTBF and mechanical reliability. All internal printed circuit boards are conformal coated to ensure the highest reliability. Heat sink style fins on the top and bottom of the unit ensure the unit will meet its temperature specifications without any forced air cooling, though the unit is also suitable for use with a cold plate if appropriate.

The DNR-MIL-6 is available in different deployment options, including: PowerDNA, UEIPAC, UEIMODBUS, UEISIM and UEIOPCUA.

PowerDNA: DNR-MIL-6

In PowerDNA mode, the RACKtangle operates as a slave I/O device, running under the control of a host PC. All application code in this mode is created and run on the host. PowerDNR mode offers almost unprecedented software support including:

- All popular operating systems, including Windows, Linux, VxWorks, QNX, RTX and InTime
- All popular programming languages, including VB, VB.NET, C, C#, C++, JAVA
- All popular application packages, including MATLAB, Simulink, LabVIEW, and more.



The new DNR-MIL-6 provides 6 I/O slots and uses standard DNR-series I/O boards (e.g. DNR-AI-217). It is available in the standard PowerDNR configuration or as a UEIPAC, UEISIM, or UEIOPC.

UEIPAC 600-MIL

When deployed as a UEIPAC, the standard firmware running on a RACKtangle is replaced by either a Linux or VxWorks operating system. The user then writes the Linux/VxWorks application that runs on the DNR-MIL-6. In this mode, the DNR-MIL-6 can run fully stand-alone, or may be linked to a SCADA host via the Ethernet.

UEISIM 600-MIL

Simulink users will appreciate the ability to build models in Simulink, compile them in Embedded Coder and then deploy them on the UEISIM hardware. It's an ideal platform for testing models on actual hardware. Once the model is proven, it can be deployed using the exact same hardware.

UEIMODBUS 600-MIL

Users needing a compact, rugged Modbus TCP I/O slave will appreciate UEIMODBUS. The rugged, IP66/NEMA6 sealed DNR-MIL-6 allows you to deploy your I/O system in the field, without any additional enclosure and protection.

UEIOPCUA 600-MIL

The rugged UEIOPC 600-MIL acts as a standalone OPC-UA server (not dependent on Windows), supporting the OPC-UA Historian functionality. System configuration is made easy by an intuitive, easy to use web/HTML interface.

The DNR-MIL-6 platform is 100% COTS, made in the USA and supported by UEI's family of over 90 compatible analog, digital and interface I/O boards, including analog inputs up to 24-bits, thermocouples, RTDs, ICP/IEPE, ARINC-429/453/708, MIL-STD-1553, CAN, RVDT/LVDT, synchro/resolver, RS-232/422/485, strain gauge, quadrature encoder, high-voltage analog outputs (up to 115 VDC) with high drive analog output (up to 200 mA), function generator outputs and more.

Whether your application is on a ship or boat, in an aircraft, in a rocket, on an outdoor test cell, on an oil platform or simply going to be left outside and exposed to the elements, the DNR-MIL-6 is an ideal solution. Of course if you need fewer I/O, you should consider the 4-slot 6.2" x 7.1" x 8.7" DNA-MIL Cube, which offers many of the same features and options, but offers slots for up to 4 I/O boards in a smaller chassis. If you need more I/O, please consider the DNR-MIL, which offers identical electronic features, but is larger and provides 12 I/O slots.

Technical Specifications

DNR-MIL-6 (Power DNA mode)

| • | |
|---------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Computer Interface | MIL series ruggedized chassis |
| Primary Ethernet Port | 10/100/1000Base-T, 38999 connector |
| Diagnostic Port | 10/100/1000Base-T, 38999 connector |
| Configuration/Serial Port | RS-232, 38999 connector |
| Synchronization Options | IEEE-1588/PTP DNR-SYNC-1G series cables and boards provide both clock and trigger sync signals DNR-IRIG-650 board provides IRIG and GPS time synchronization |
| I/O Board Support | |
| Series supported | All DNR-series boards |
| Processor/system | |
| CPU | Freescale 8347, 400 MHz, 32-bit |
| Memory (RAM) | 256 MB |
| Memory (Flash) | 32 MB |
| Host Communications | |
| Distance from host | 100 meters max, CAT5/6 cable |
| Ethernet data transfer rate | 20 MB per second |
| Analog data transfer rate | >6 MS/s. Capable of sustained transfer in any RACKtangle configuration |
| DMAP/VMAP real-time I/O mode | Update >1,000 I/O channels at 4 kHz, guaranteed |
| Physical Dimensions / Weight | |
| 6 I/O slots | 11.6" W x 6.4" D x 7.0" H, 16 lbs. including I/O boards |
| Environmental | |
| Electrical Isolation | 350 Vrms |
| Temp (operating) | -40 °C to 70 °C |
| Temp (storage) | -40 °C to 70 °C |
| Humidity | 0 to 95%, non-condensing |
| Vibration | MIL-STD-810G plus the IEC standards below |
| (IEC 60068-2-64) | 10–500 Hz, 5 g (rms), broadband random |
| (IEC 60068-2-6) | 10–500 Hz, 5 g, sinusoidal |
| Shock | MIL-STD-810G plus the IEC standards below |
| (IEC 60068-2-27) | 100 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations |
| Altitude | 70,000 feet, maximum |
| EMI / RFI | Designed to meet MIL-STD-461 |
| Sealing | Default unit sealed to IP 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes if desired. |
| Power Requirements | |
| Voltage | 9–36 VDC (115/220 VAC adaptor available) |
| Power | 12 W (not including I/O boards) |
| Power Quality requirement | Designed to meet MIL-STD-1275 |
| Reliability | |
| MTBF | 100,000 hours |

UEIPAC 600-MIL

| Computer Interface | MIL series ruggedized chassis |
|------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Primary Ethernet Port | 10/100/1000Base-T, 38999 connector |
| Diagnostic Port* | 10/100/1000Base-T, 38999 connector *Alternatively can be teamed/bonded with primary port. |
| Configuration/Serial Port | RS-232, 38999 connector |
| USB Port | USB 2.0 fully supported |
| Synchronization Options | DNR-SYNC-1G series cables and boards provide both clock and trigger sync signals. DNR-IRIG-650 board provides IRIG and GPS time synchronization PTP client provides software implementation of IEEE-1588 |
| I/O Board Support | |
| Series supported | All DNR-series boards |
| Software / Operating System | |
| Embedded OS | Linux, kernel 4.4.x (VxWorks Available) |
| Real-time support | Xenomai, Linux RT or VxWorks support |
| Development Language | C/C++, Eclipse IDE support |
| Development Environments | Linux PC or Cygwin Windows environment |
| EPICS CAS interface | Yes |
| SNMP Library | Yes |
| OS royalties | None |
| Processor/system | Hone |
| CPU | Freescale 8347, 400 MHz, 32-bit |
| Memory | 256 MB (128 MB available for |
| FLASH memory | application software) 32 MB (16 MB available for |
| Solid State Hard Drive | user applications) Up to 64 GByte |
| USB drive interface | Standard USB 2.0 port |
| Physical Dimensions / Weight | |
| 6 I/O slots | 10.6" x 7.0" x 6.4" 16 lbs. including I/O boards |
| Environmental | |
| Electrical Isolation | 350 Vrms |
| Temp (operating) | -40 °C to 70 °C |
| Temp (storage) | -40 °C to 70 °C |
| Humidity | 0 to 95%, non-condensing |
| Vibration | MIL-STD-810G plus the IEC standards below |
| (IEC 60068-2-64) | 10–500 Hz, 5 g (rms), broadband random |
| (IEC 60068-2-6) | 10–500 Hz, 5 g, sinusoidal |
| Shock | MIL-STD-810G plus the IEC standards below |
| (IEC 60068-2-27) | 10 g, 3 ms half sine, 18 shocks at 6 orientations; 30 g, 11 ms half sine, 18 shocks at 6 orientations |
| Altitude | 70,000 feet, maximum |
| EMI / RFI | Designed to meet MIL-STD-461 |
| Sealing | Default unit sealed to IP 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes if desired. |
| Power Requirements | |
| Voltage | 9–36 VDC (115/220 VAC adaptor available) |
| Power | 12 Watts (not including I/O boards) |
| Power Quality requirement | Designed to meet MIL-STD-1275 |
| Reliability | |
| MTBF | 100,000 hours |
| | |

Technical Specifications

UEIMODBUS 600-MIL

| | MIL sovies were dired shossis |
|--------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Computer Interface | MIL series ruggedized chassis |
| Primary Ethernet Port | 10/100/1000Base-T, 38999 connector |
| Diagnostic Port | 10/100/1000Base-T, 38999 connector |
| Net Teaming/bonding | Supported |
| Config/Serial Port | On LAN/COM 38999 connector |
| USB Port | n/a on UEIModbus |
| I/O Board Support | |
| Series supported | All DNR-series boards |
| Software / Operating System | |
| Embedded OS | Linux, kernel 4.4.89 |
| Real-time support | Standard Linux kernel |
| Processor/system | |
| CPU | Freescale 8347 or 8347E, 400 MHz, 32-bit |
| Memory | 256 MB, 228 MB available to user apps |
| FLASH memory | 32 MB standard / 128 MB optional |
| LASITITIETIOTY | 16 MB / 112 MB available for user apps |
| Solid-State Hard Drive | *Optional 8 or 16 GByte drives available |
| SD card interface | SD cards up to 32 GByte |
| Physical Dimensions / Weight | |
| 6 I/O slots | 10.6" x 7.0" x 6.4" 16 lbs. including I/O boards |
| Environmental | |
| Temperature (operating) | -40 °C to 85 °C (power dissipation of actual system may require derated maximum temperature) |
| Temperature (storage) | -40 °C to 85 °C |
| Humidity | 0 to 95%, non-condensing |
| Vibration | MIL-STD-810G plus the IEC standards below |
| (IEC 60068-2-64) | |
| (ILC 00000 Z 07) | |
| (IEC 60068-2-6) | 10–500 Hz, 5g (rms), broadband random |
| | 10–500 Hz, 5g (rms), broadband random 10–500 Hz, 5g, sinusoidal |
| (IEC 60068-2-6) | 10–500 Hz, 5g (rms), broadband random |
| (IEC 60068-2-6) Shock | 10–500 Hz, 5g (rms), broadband random 10–500 Hz, 5g, sinusoidal MIL-STD-810G plus the IEC standards below 100g, 3 ms half sine, 18 shocks at 6 orientations; 30g, 11 ms half sine, 18 shocks at |
| (<i>IEC 60068-2-6</i>) Shock (IEC 60068-2-27) | 10–500 Hz, 5g (rms), broadband random 10–500 Hz, 5g, sinusoidal MIL-STD-810G plus the IEC standards below 100g, 3 ms half sine, 18 shocks at 6 orientations; 30g, 11 ms half sine, 18 shocks at 6 orientations |
| (IEC 60068-2-6) Shock (IEC 60068-2-27) Altitude EMI / RFI Sealing | 10–500 Hz, 5g (rms), broadband random 10–500 Hz, 5g, sinusoidal MIL-STD-810G plus the IEC standards below 100g, 3 ms half sine, 18 shocks at 6 orientations; 30g, 11 ms half sine, 18 shocks at 6 orientations 70,000 feet, maximum |
| (<i>IEC 60068-2-6</i>) Shock (<i>IEC 60068-2-27</i>) Altitude EMI / RFI | 10-500 Hz, 5g (rms), broadband random 10-500 Hz, 5g, sinusoidal MIL-STD-810G plus the IEC standards below 100g, 3 ms half sine, 18 shocks at 6 orientations; 30g, 11 ms half sine, 18 shocks at 6 orientations 70,000 feet, maximum Designed to meet MIL-STD-461 Default unit sealed to IP 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes |
| (IEC 60068-2-6) Shock (IEC 60068-2-27) Altitude EMI / RFI Sealing | 10-500 Hz, 5g (rms), broadband random 10-500 Hz, 5g, sinusoidal MIL-STD-810G plus the IEC standards below 100g, 3 ms half sine, 18 shocks at 6 orientations; 30g, 11 ms half sine, 18 shocks at 6 orientations 70,000 feet, maximum Designed to meet MIL-STD-461 Default unit sealed to IP 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes |
| (IEC 60068-2-6) Shock (IEC 60068-2-27) Altitude EMI / RFI Sealing Power Requirements | 10–500 Hz, 5g (rms), broadband random 10–500 Hz, 5g, sinusoidal MIL-STD-810G plus the IEC standards below 100g, 3 ms half sine, 18 shocks at 6 orientations; 30g, 11 ms half sine, 18 shocks at 6 orientations 70,000 feet, maximum Designed to meet MIL-STD-461 Default unit sealed to IP 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes if desired. 9–36 VDC designed to meet |

UEISIM 600-MIL

| Computer Interface | MIL series ruggedized chassis |
|--------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Primary Ethernet Port | 10/100/1000Base-T, 38999 connector |
| Diagnostic Port | 10/100/1000Base-T, 38999 connector |
| Net Teaming/bonding | Supported in Linux OS |
| Config/Serial Port | On LAN/COM 38999 connector |
| USB Port | USB 2.0 fully supported |
| I/O Board Support | |
| Series supported | All DNR series boards |
| Software / Operating System | |
| Embedded OS | Linux, kernel 4.4.89 |
| Real-time support | Xenomai RTOS is supported in Linux, but file I/O is not available |
| EPICS CAS interface | Yes (Linux version) |
| SNMP Library | Yes |
| Processor/system | |
| CPU | Freescale 8347 or 8347E, 400 MHz, 32-bit |
| Memory | 256 MB, 228 MB available to user apps |
| FLASH memory | 32 MB standard/128 MB optional 16 MB/112 MB available for user apps |
| Solid-State Hard Drive* | Optional 8 or 16 GB drives available |
| SD card interface* | SD cards up to 32 GB |
| USB drive interface | Standard USB 2.0 port |
| Physical Dimensions / Weight | |
| 6 I/O slots | 10.6" x 7.0" x 6.4" 16 lbs. including I/O boards |
| Environmental | |
| Temperature (operating) | -40 °C to 85 °C (power dissipation of actual system may require derated maximum temperature) |
| Temperature (storage) | -40 °C to 85 °C |
| Humidity | 0 to 95%, non-condensing |
| Vibration | MIL-STD-810G plus the IEC specs below |
| (IEC 60068-2-64) | 10–500 Hz, 5g (rms), broadband random |
| (IEC 60068-2-6) | 10–500 Hz, 5g, sinusoidal |
| Shock | MIL-STD-810G plus the IEC specs below |
| (IEC 60068-2-27) | 100g, 3 ms half sine, 18 shocks at 6 orientations; 30g, 11 ms half sine, 18 shocks at 6 orientations |
| | o offertuations |
| Altitude | 70,000 feet, maximum |
| Altitude EMI / RFI | |
| | 70,000 feet, maximum |
| EMI / RFI | 70,000 feet, maximum Designed to meet MIL-STD-461 Default unit sealed to IP 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes |
| EMI / RFI Sealing | 70,000 feet, maximum Designed to meet MIL-STD-461 Default unit sealed to IP 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes |
| EMI / RFI Sealing Power Requirements | 70,000 feet, maximum Designed to meet MIL-STD-461 Default unit sealed to IP 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes if desired. 9–36 VDC designed to meet |
| EMI / RFI Sealing Power Requirements | 70,000 feet, maximum Designed to meet MIL-STD-461 Default unit sealed to IP 66 or better. Pressure relief valves support continuou altitude changes of 5000 fpm. Units can be configured with bottom weep holes if desired. 9–36 VDC designed to meet |

*The SD cards and SSD devices used are not built by UEI. As we do not control the source, we cannot offer our 10-year availability guarantee on these devices.

UEIOPCUA 600-MIL

| UEIOPCUA 600-MIL | |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Computer Interface | MIL series ruggedized chassis |
| Primary Ethernet Port | 10/100/1000Base-T, 38999 connector |
| Diagnostic Port | 10/100/1000Base-T, 38999 connector |
| Net Teaming/bonding | Supported |
| Config/Serial Port | on LAN/COM 38999 connector |
| USB Port | n/a on UEIOPC-UA |
| I/O Board Support | |
| Series supported | DNA/DNR-series |
| Software / Operating System | |
| Embedded OS | Linux, kernel 4.4.89 |
| Real-time support | Standard Linux kernel |
| Processor/system | |
| CPU | Freescale 8347 or 8347E, 400 MHz, 32-bit |
| Memory | 256 MB, 228 MB available to user apps |
| FLASH memory | 32 MB standard / 128 MB optional 16 MB / 112 MB available for user apps |
| Solid-State Hard Drive | Optional 8 or 16 GByte drives available* |
| SD card interface | SD cards up to 32 GB |
| Physical Dimensions / Weight | |
| 6 I/O slots | 10.6" x 7.0" x 6.4" 16 lbs. including I/O boards |
| | |
| Environmental | |
| Environmental Temperature (operating) | -40 °C to 85 °C (power dissipation of actual system may require derated maximum temperature) |
| | of actual system may require derated |
| Temperature (operating) | of actual system may require derated maximum temperature) |
| Temperature (operating) Temperature (storage) | of actual system may require derated maximum temperature) - 40 °C to 85 °C |
| Temperature (operating) Temperature (storage) Humidity | of actual system may require derated maximum temperature) -40 °C to 85 °C 0 to 95%, non-condensing |
| Temperature (operating) Temperature (storage) Humidity Vibration | of actual system may require derated maximum temperature) - 40 °C to 85 °C 0 to 95%, non-condensing MIL-STD-810G plus the IEC specs below |
| Temperature (operating) Temperature (storage) Humidity Vibration (<i>IEC 60068-2-64</i>) | of actual system may require derated maximum temperature) -40 °C to 85 °C 0 to 95%, non-condensing MIL-STD-810G plus the IEC specs below 10–500 Hz, 5g (rms), broadband random |
| Temperature (operating) Temperature (storage) Humidity Vibration (<i>IEC 60068-2-64</i>) (<i>IEC 60068-2-6</i>) | of actual system may require derated maximum temperature) - 40 °C to 85 °C 0 to 95%, non-condensing MIL-STD-810G plus the IEC specs below 10–500 Hz, 5g (rms), broadband random 10–500 Hz, 5g, sinusoidal |
| Temperature (operating) Temperature (storage) Humidity Vibration (IEC 60068-2-64) (IEC 60068-2-6) Shock | of actual system may require derated maximum temperature) -40 °C to 85 °C 0 to 95%, non-condensing MIL-STD-810G plus the IEC specs below 10–500 Hz, 5g (rms), broadband random 10–500 Hz, 5g, sinusoidal MIL-STD-810G plus the IEC specs below 100g, 3 ms half sine, 18 shocks at 6 orientations; 30g, 11 ms half sine, 18 shocks at |
| Temperature (operating) Temperature (storage) Humidity Vibration (IEC 60068-2-64) (IEC 60068-2-6) Shock (IEC 60068-2-27) | of actual system may require derated maximum temperature) -40 °C to 85 °C 0 to 95%, non-condensing MIL-STD-810G plus the IEC specs below 10–500 Hz, 5g (rms), broadband random 10–500 Hz, 5g, sinusoidal MIL-STD-810G plus the IEC specs below 100g, 3 ms half sine, 18 shocks at 6 orientations; 30g, 11 ms half sine, 18 shocks at 6 orientations |
| Temperature (operating) Temperature (storage) Humidity Vibration (IEC 60068-2-64) (IEC 60068-2-6) Shock (IEC 60068-2-27) Altitude EMI / RFI Sealing | of actual system may require derated maximum temperature) -40 °C to 85 °C 0 to 95%, non-condensing MIL-STD-810G plus the IEC specs below 10–500 Hz, 5g (rms), broadband random 10–500 Hz, 5g, sinusoidal MIL-STD-810G plus the IEC specs below 100g, 3 ms half sine, 18 shocks at 6 orientations; 30g, 11 ms half sine, 18 shocks at 6 orientations 70,000 feet, maximum |
| Temperature (operating) Temperature (storage) Humidity Vibration (IEC 60068-2-64) (IEC 60068-2-6) Shock (IEC 60068-2-27) Altitude EMI / RFI Sealing Power Requirements | of actual system may require derated maximum temperature) - 40 °C to 85 °C 0 to 95%, non-condensing MIL-STD-810G plus the IEC specs below 10–500 Hz, 5g (rms), broadband random 10–500 Hz, 5g, sinusoidal MIL-STD-810G plus the IEC specs below 100g, 3 ms half sine, 18 shocks at 6 orientations; 30g, 11 ms half sine, 18 shocks at 6 orientations 70,000 feet, maximum Designed to meet MIL-STD-461 Default unit sealed to IP 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes |
| Temperature (operating) Temperature (storage) Humidity Vibration (IEC 60068-2-64) (IEC 60068-2-6) Shock (IEC 60068-2-27) Altitude EMI / RFI Sealing | of actual system may require derated maximum temperature) - 40 °C to 85 °C 0 to 95%, non-condensing MIL-STD-810G plus the IEC specs below 10–500 Hz, 5g (rms), broadband random 10–500 Hz, 5g, sinusoidal MIL-STD-810G plus the IEC specs below 100g, 3 ms half sine, 18 shocks at 6 orientations; 30g, 11 ms half sine, 18 shocks at 6 orientations 70,000 feet, maximum Designed to meet MIL-STD-461 Default unit sealed to IP 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes |
| Temperature (operating) Temperature (storage) Humidity Vibration (IEC 60068-2-64) (IEC 60068-2-6) Shock (IEC 60068-2-27) Altitude EMI / RFI Sealing Power Requirements | of actual system may require derated maximum temperature) - 40 °C to 85 °C 0 to 95%, non-condensing MIL-STD-810G plus the IEC specs below 10–500 Hz, 5g (rms), broadband random 10–500 Hz, 5g, sinusoidal MIL-STD-810G plus the IEC specs below 100g, 3 ms half sine, 18 shocks at 6 orientations; 30g, 11 ms half sine, 18 shocks at 6 orientations 70,000 feet, maximum Designed to meet MIL-STD-461 Default unit sealed to IP 66 or better. Pressure relief valves support continuous altitude changes of 5000 fpm. Units can be configured with bottom weep holes if desired. |

*The SD cards and SSD devices used are not built by UEI. As we do not control the source, we cannot offer our 10-year availability guarantee on these devices.

Cables, Connectors and screw terminal panel accessories

Connectors

All connections to the DNR-MIL-6 are made through standard, COTS, nickel plated 38999 connectors. I/O board connections are made through 128-pin connectors where each I/O board utilizes up to 62 of the 128 pins. The Ethernet, USB, diagnostic Serial, Sync, and hardware reset connections are via 37-pin connectors. Power supply and an auxiliary synch bus connections are through a 13-pin connector.

Cables

Though most customers will design custom cables for their deployed systems, customers working on prototypes and/or those building "one-off" systems may desire the ability to connect to the DNR-MIL-6 using more traditional, commercial connections (e.g. RJ-45 for the Ethernet ports).

For these customers, UEI offers a complete array of cables and screw terminal panels that will provide direct access to all signals routed in and out of the chassis.

LAN/Power Cables

DNA-CBL-LAN-06 Communications cable

6 foot cable connecting the 37-pin LAN/COM/USB port connector to standard commercial connectors. Ethernet ports come out to RJ-45, the serial port to a DB-9 and the USB ports to standard USB jacks.

DNA-CBL-1315-03 Power supply cable

Connects the 13-pin power/sync connector to a standard female DB-15 connector.

I/O board cables

Each 128 pin I/O 38999 connector provides the I/O connectivity for two I/O slots within the DNR-MIL-6. UEI I/O boards utilize either 37- or 62-pin D connectors and these connectors are mapped as follows.

The left I/O slot (even slot #) maps to pins 1-62 on the 128 pin 38999. The right I/O slot (even slot #) is mapped to pins 65-126 on the 38999. Note that the 37-pin based boards simply do not use pins 38-62. For this reason, most applications can standardize on 62-pin cables and screw terminal panels and simply ignore "no connection" pins. The exception to this is the STP boards that have been specifically designed for use with 37-pin boards (e.g. DNA-STP-207TC). For these boards 37-pin are also available. Also, as some I/O slots may not be utilized in a given application, cables with a single 37-pin or 62-pin D connector are also available.

The following cables provide the same I/O connectivity as the standard, commercial DNA-CBL-37S and DNA-CBL-62 series cables.

DNA-CBL-12862-05: 5 ft male 128-pin 38999 to 2x DB-62M

DNA-CBL-12837-05: 5 ft male 128-pin 38999 to 2x DB-37F

DNA-CBL-6237M-03: 3 ft male RoHS 128-pin 38999 to 1x DB-37F and 1x DB-62M

DNA-CBL-62M-03: 3 ft male 128-pin 38999 to 1x DB-62M

DNA-CBL-37M-03: 3 ft male 128-pin 38999 to 1x DB-37F

Screw Terminal Panels

| DNA-STP-37 | Standard 37-pin screw terminal panel, suitable for use with all 37-pin I/O boards and cables. |
|--------------|-----------------------------------------------------------------------------------------------|
| DNA-STP-62 | Standard 62-pin screw terminal panel, suitable for use with all 62-pin I/O boards and cables. |
| DNA-STP-3762 | Standard 37-pin screw terminal panel, providing both |

37- and 62-pin connectors and suitable for use with any combination of I/O board.

38999 Connector Pinouts

128-pin I/0 — mating connector required: D38999/26FJ35PN



| Pin # | I/O slot | Board Pin | Pir |
|-------|----------|-----------|---------------------|
| 1 | 1 | 1 | 24 |
| 2 | 1 | 2 | 2 |
| 3 | 1 | 3 | 2 |
| 4 | 1 | 4 | 2 ⁻ 2 |
| 5 | 1 | 5 | 2 |
| 6 | 1 | 6 | 2 |
| 7 | 1 | 7 | 3 |
| 8 | 1 | 8 | 3 |
| 9 | 1 | 9 | 3 |
| 10 | 1 | 10 | 3 |
| 11 | 1 | 11 | 34 |
| 12 | 1 | 12 | 3 |
| 13 | 1 | 13 | 3 |
| 14 | 1 | 14 | 3 |
| 15 | 1 | 15 | 38 |
| 16 | 1 | 16 | 3 |
| 17 | 1 | 17 | 4 |
| 18 | 1 | 18 | 4 |
| 19 | 1 | 19 | 4 |
| 20 | 1 | 20 | 4 |
| 21 | 1 | 21 | 4 |
| 22 | 1 | 22 | 4 |
| 23 | 1 | 23 | 4 |
| | | | |

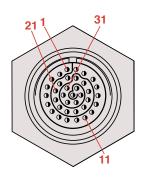
| Pin # | I/O slot | Board Pin |
|-------|----------|-----------|
| 24 | 1 | 24 |
| 25 | 1 | 25 |
| 26 | 1 | 26 |
| 27 | 1 | 27 |
| 28 | 1 | 28 |
| 29 | 1 | 29 |
| 30 | 1 | 30 |
| 31 | 1 | 31 |
| 32 | 1 | 32 |
| 33 | 1 | 33 |
| 34 | 1 | 34 |
| 35 | 1 | 35 |
| 36 | 1 | 36 |
| 37 | 1 | 37 |
| 38* | 1 | 38 |
| 39 | 1 | 39 |
| 40 | 1 | 40 |
| 41 | 1 | 41 |
| 42 | 1 | 42 |
| 43 | 1 | 43 |
| 44 | 1 | 44 |
| 45 | 1 | 45 |
| 46 | 1 | 46 |

| Pin # | I/O slot | Board Pin |
|-------|----------|-----------------|
| 47 | 1 | 47 |
| 48 | 1 | 48 |
| 49 | 1 | 49 |
| 50 | 1 | 50 |
| 51 | 1 | 51 |
| 52 | 1 | 52 |
| 53 | 1 | 53 |
| 54 | 1 | 54 |
| 55 | 1 | 55 |
| 56 | 1 | 56 |
| 57 | 1 | 57 |
| 58 | 1 | 58 |
| 59 | 1 | 59 |
| 60 | 1 | 60 |
| 61 | 1 | 61 |
| 62 | 1 | 62 |
| 63 | n/a | n/a |
| 64 | n/a | n/a |
| 65 | 2 | 1 |
| 66 | 2 | 2 |
| 67 | 2 | 3 |
| 68 | 2 | 4 |
| 69 | 2 | 5 |
| 70 | 2 | 6 |
| 71 | 2 | 7 |
| 72 | 2 | 8 |
| 73 | 2 | 9 |
| 74 | 2 | 10 |
| 75 | 2 | 11 |
| 76 | 2 | 12 |
| 77 | 2 | 13 |
| 78 | 2 | 14 |
| 79 | 2 | 15 |
| 80 | 2 | 16 |
| 81 | 2 | 17 |
| 82 | 2 | 18 |
| 83 | 2 | 19 |
| 84 | 2 | 20 |
| 85 | 2 | 21 |
| 86 | 2 | 22 |
| 87 | 2 | 23 |
| , | | *Dinc 20 62 arc |

| Pin # | I/O slot | Board Pin |
|-------|--------------------|-----------|
| 88 | 2 | 24 |
| 89 | 2 | 25 |
| 90 | 2 | 26 |
| 91 | 2 | 27 |
| 92 | 2 | 28 |
| 93 | 2 | 29 |
| 94 | 2 | 30 |
| 95 | 2 | 31 |
| 96 | 2 | 32 |
| 97 | 2 | 33 |
| 98 | 2 | 34 |
| 99 | 2 | 35 |
| 100 | 2 | 36 |
| 101 | 2 | 37 |
| 102 | 2 | 38 |
| 103 | 2 | 39 |
| 104 | 2 | 40 |
| 105 | 2 | 41 |
| 106 | 2 | 42 |
| 107 | 2 | 43 |
| 108 | 2 | 44 |
| 109 | 2 | 45 |
| 110 | 2 | 46 |
| 111 | 2 | 47 |
| 112 | 2 | 48 |
| 113 | 2 | 49 |
| 114 | 2 | 50 |
| 115 | 2 | 51 |
| 116 | 2 | 52 |
| 117 | 2 | 53 |
| 118 | 2 | 54 |
| 119 | 2 | 55 |
| 120 | 2 | 56 |
| 120 | 2 | 57 |
| 121 | 2 | 58 |
| 123 | 2 | 59 |
| 123 | 2 | 60 |
| 125 | 2 | 61 |
| 125 | 2 | 62 |
| 120 | 2 | n/a |
| 127 | 2 | n/a |
| | /0 slot 1 contains | |

*Pins 38-62 are not applicable if I/O slot 1 contains a 37-pin board

37-pin LAN / COM port — mating connector required: D38999/26WD35PN



| Pin number | Pin designation |
|------------|-----------------|
| 1 | LAN0 TX+ / DA+ |
| 2 | LAN0 RX+ / DB+ |
| 3 | LAN0 nc / DC- |
| 4 | LAN0 nc / DD+ |
| 5 | Shield |
| 6 | Lan1 TX+ / DA+ |
| 7 | LAN1 RX+ / DB+ |
| 8 | LAN1 nc / DC- |
| 9 | LAN1 nc / DD+ |
| 10 | Shield |
| 11 | Misc In |
| 12 | USB1 P+ |
| 13 | USB1 D+ |
| | |

| Pin number | Pin designation |
|------------|-----------------|
| 14 | USB2 P+ |
| 15 | USB2 P- |
| 16 | USB2 D+ |
| 17 | USB2 D- |
| 18 | LAN0 TX- / DA- |
| 19 | LAN0 nc / DC+ |
| 20 | LAN0 RX- / DB- |
| 21 | LAN0 nc / DD- |
| 22 | LAN1 TX- / DA- |
| 23 | LAN1 nc / DC+ |
| 24 | LAN1 RX- / DB- |
| 25 | LAN1 nc / DD- |
| 26 | Misc Out |

| Pin number | Pin designation |
|------------|-----------------|
| 27 | USB1 P- |
| 28 | USB1 D- |
| 29 | Sync Clock Out |
| 30 | Sync Trig Out |
| 31 | RS232 TX |
| 32 | RS232 RX |
| 33 | RS232 GND |
| 34 | Sync Clock In |
| 35 | Sync Trig In |
| 36 | Sync +5V |
| 37 | Sync Gnd |

13-pin power connector — mating connector required: D38999/26FB35PN



| Pin # | Pin Designation |
|-------|------------------|
| 1 | GND |
| 2 | GND |
| 3 | GND |
| 4 | Vcc (9-36 VDC) |
| 5 | Vcc (9-36 VDC) |
| 6 | Vcc (9-36 VDC) |
| 7 | Sync In2 / reset |
| 8 | Sync In0 |
| 9 | Sync In1 |
| 10 | Sync Gnd |
| 11 | Sync Out1 |
| 12 | Sync +5V |
| 13 | Sync Out0 |